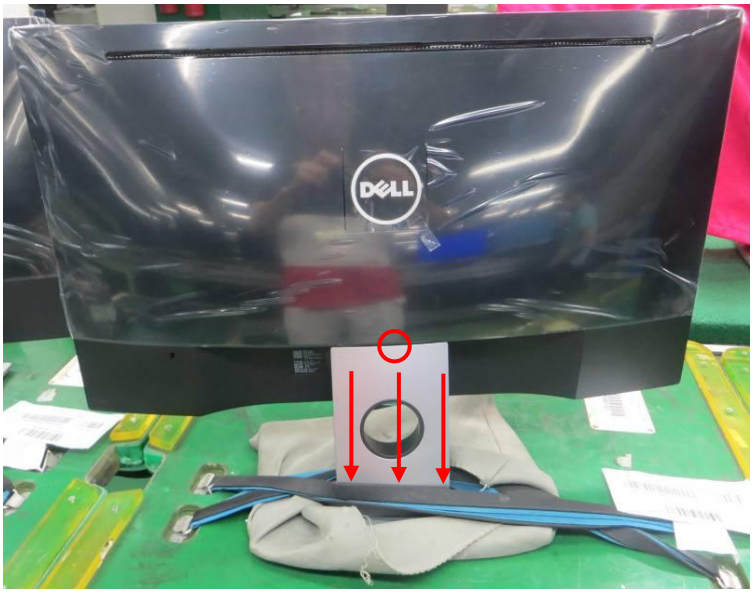
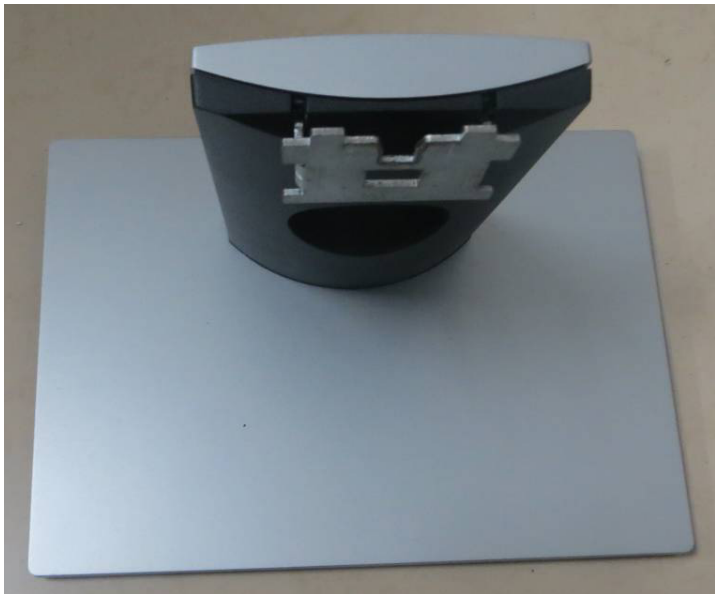
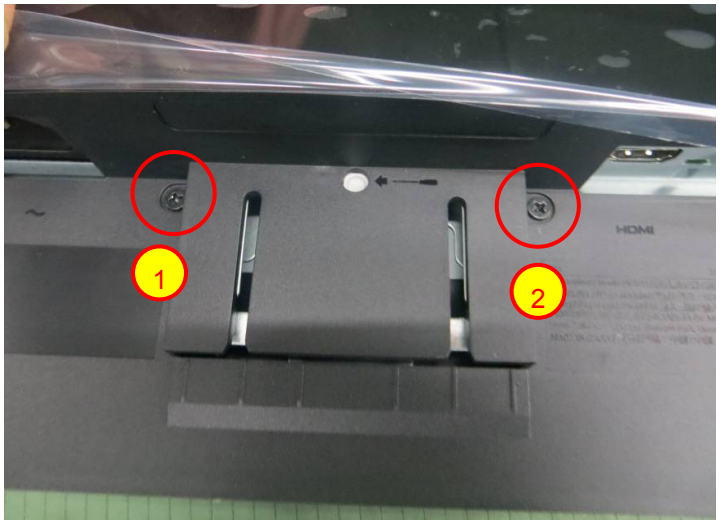
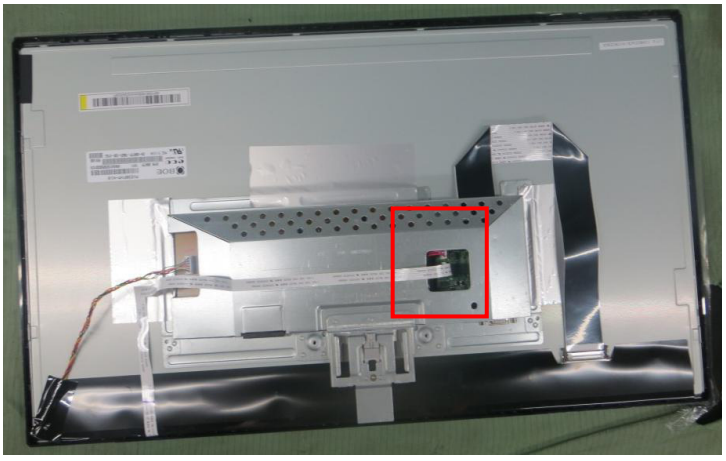
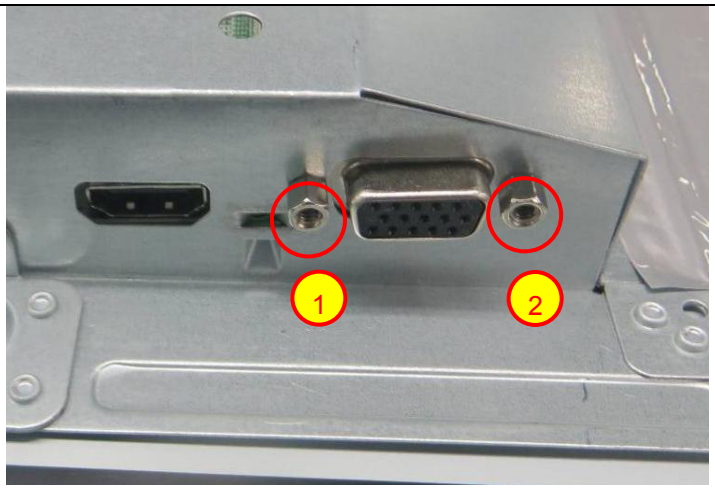
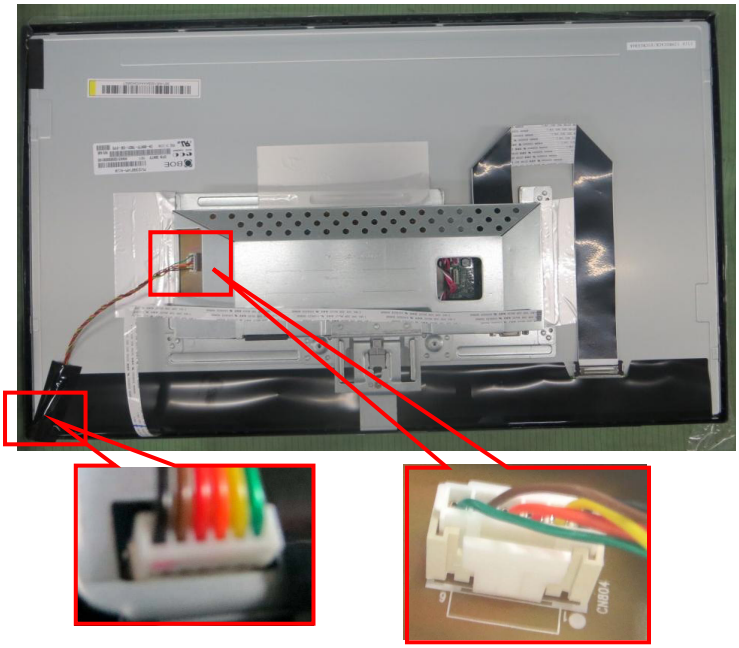
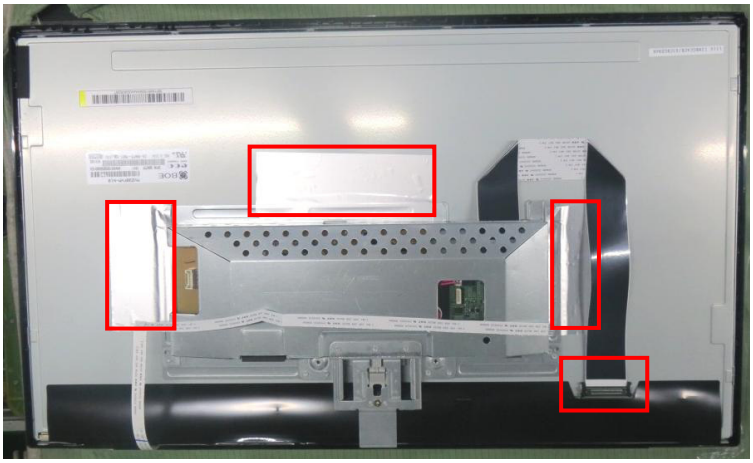
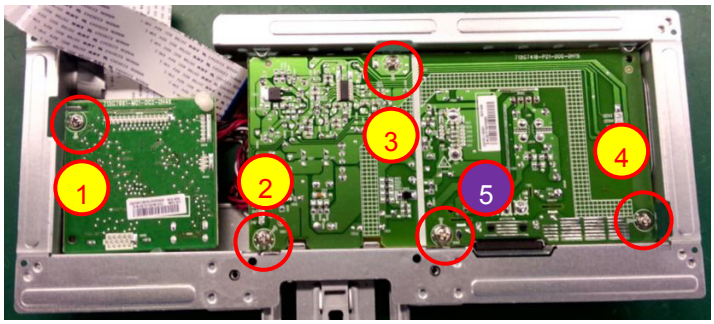
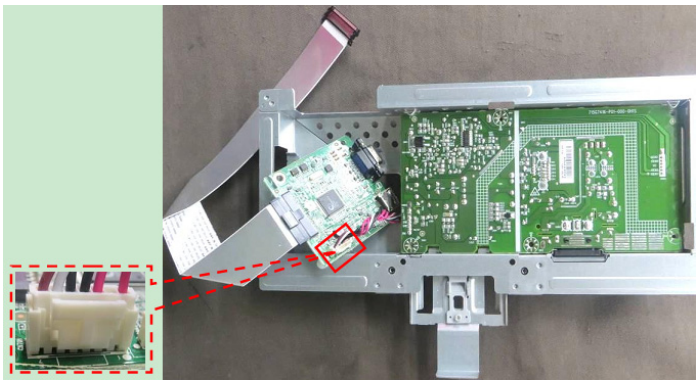
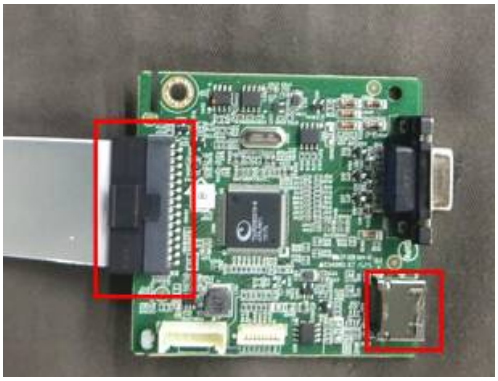
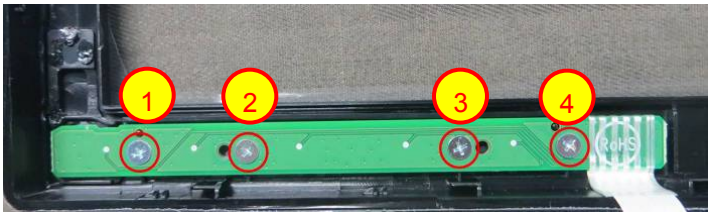
1. Disassembly Procedures:

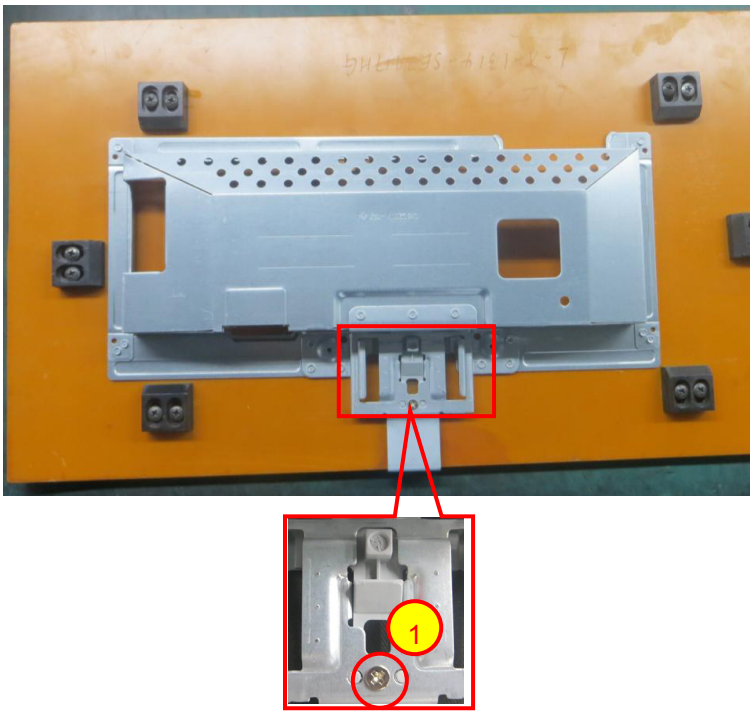
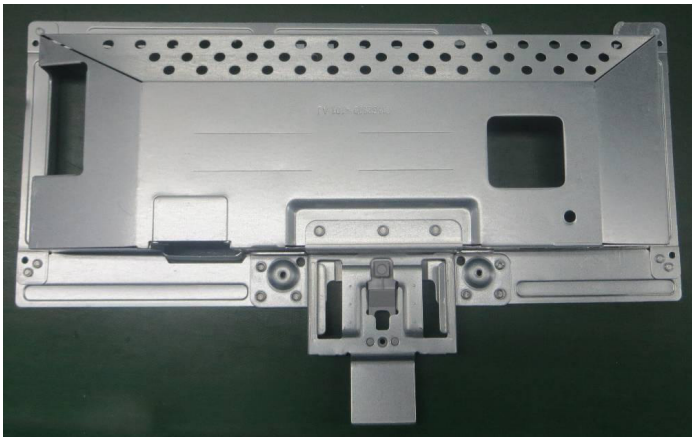
Step	Figure	Remark
S1.Before disassemble		Turn off power, Unplug external cables from product
S2.Remove the STAND-BASE ASS'Y	 	To remove the stand: Press the button on the red circle then pull out the stand follow the arrow, stand will be remove. Note: To prevent scratches on the LCD screen while removing the stand, ensure that the monitor is placed on a soft, clean surface.

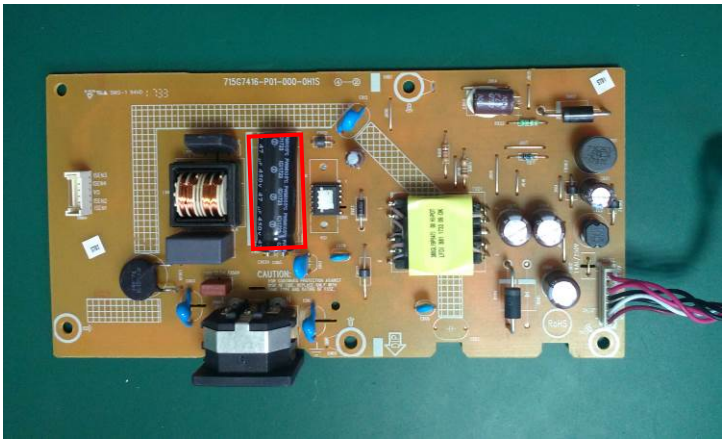
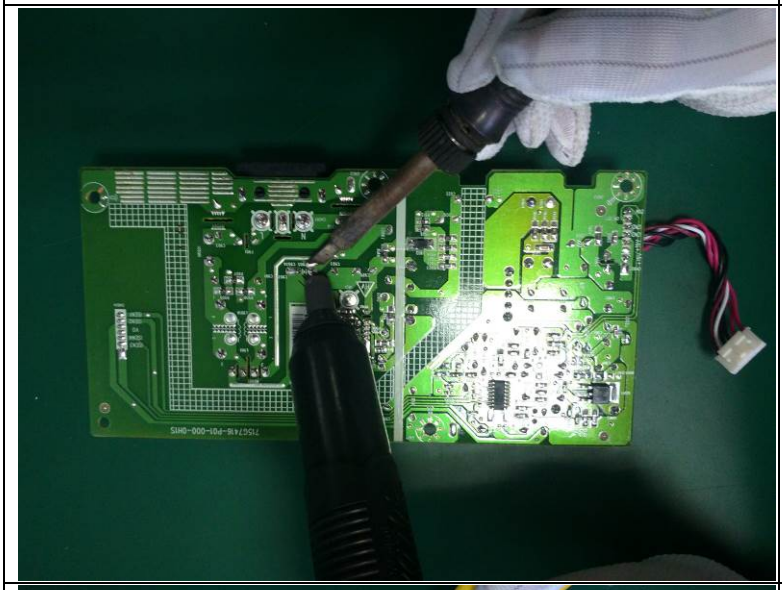
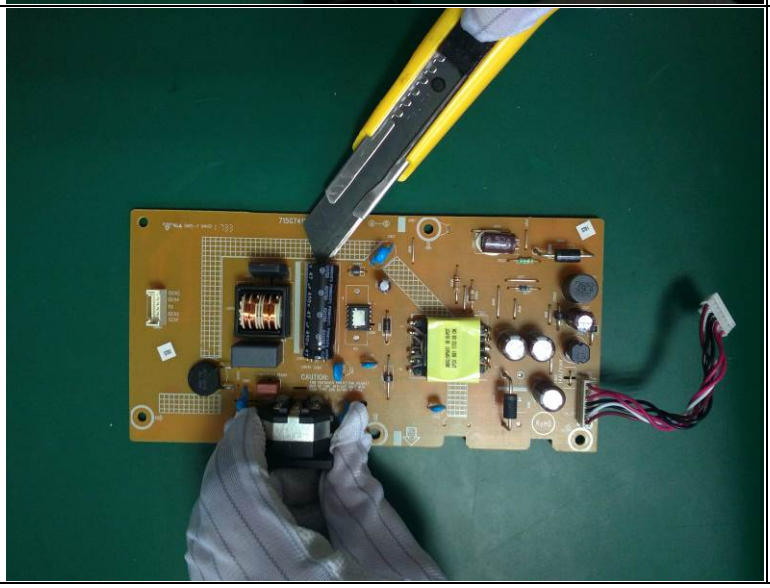
S3.Remove the REAR COVER	 	Use a Philips-head screwdriver to remove 2 screws for unlocking mechanisms. (No.1~2 screw size=M3x4; Torque=4±1kgf.cm) Use Penknife to separate the bezel and rear cove follow the arrows in sequence, then you can take out rear cover.
S4.Disconnect the FFC cable		

S5.Remove the VGA		Use a hex screwdriver to remove 2 screws for unlocking mainboard. (No.1~2 is Hex-screw, Torque= 4.5±0.5kgf.cm)
S6.Remove the FFC cable		
S7.Remove the PAPER TAPE and panel FFC cable		

S8. Remove the MAIN FRAME	 	Remove and turn over it.

S9.Remove the MAIN &POWER BOARD	  	Use a Philips-head screwdriver to remove 5 screws for unlocking mainboard and power board (No.1~4 screw size=M4x8; Torque= 6±1kgf.cm; No.5 screw size=D3x6; Torque= 6±1kgf.cm) disconnect the cables
S10.Remove the KEY BOARD		Use a Philips-head screwdriver to remove 4 screws for unlocking Key board. (No.1~4 screw size= M2x2.5 Torque=0.9±0.4kgf.cm)
S11.The PANEL		

S12.Remove the screw		Use a Philips-head screwdriver to remove 1screws for unlocking main frame (No.1 screw size= Q3x6 Torque=4±1kgf.cm)
S13. The MAIN FRAME		
S14.The BEZEL		

S15.Remove capacitors		Remove electrolyte capacitors (red mark) from printed circuit boards
		Take out bulk cap. pin solder with soldering iron and absorber
		Lift the bulk cap. up and away from the PCB

2. Product material information

The following substances, preparations, or components should be disposed of or recovered separately from other WEEE in compliance with Article 4 of EU Council Directive 75/442/EEC.

Capacitors / condensers (containing PCB/PCT)	No used
Mercury containing components	No used
Batteries	No used
Printed circuit boards (with a surface greater than 10 square cm)	Product has printed circuit boards (with a surface greater than 10 square cm)
Component contain toner, ink and liquids	No used
Plastic containing BFR	No used
Component and waste contain asbestos	No used
CRT	No used
Component contain CFC, HCFC, HFC and HC	No used
Gas discharge lamps	No used
LCD display > 100 cm2	Product has an LCD greater than 100 cm2
External electric cable	Product has external cables
Component contain refractory ceramic fibers	No used
Component contain radio-active substances	No used
Electrolyte capacitors (height > 25mm, diameter > 25mm)	Product has electrolyte capacitors (height > 25mm, diameter > 25mm)

3. Tools Required

List the type and size of the tools that would typically can be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description:

- Phillip head Screwdriver
- Hex Screwdriver
- Penknife
- Soldering iron and absorber